

CMOS Digital Integrated Circuits Silicon Monolithic

# TC74ACT240P,TC74ACT244P

### 1. Functional Description

· Octal Bus Buffer

TC74ACT240P: INVERTED, 3-STATE OUTPUTS TC74ACT244P: NON-INVERTED, 3-STATE OUTPUTS

#### 2. General

The TC74ACT240P and TC74ACT244P are advanced high speed CMOS OCTAL BUS BUFFERs fabricated with silicon gate and double-layer metal wiring C2MOS technology.

They achieve the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The TC74ACT240P is an inverting 3-state buffer while the TC74ACT244P is non-inverting. Both devices have two active-low output enables.

These devices are designed to be used in such applications as 3-state memory address drivers.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

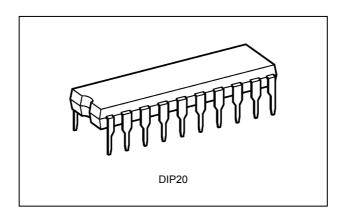
#### 3. Features

- (1) High speed: Propagation delay time = 5.0 ns (typ.) at  $V_{CC} = 5.0 \text{ V}$
- (2) Low power dissipation:  $I_{CC} = 8.0 \mu A \text{ (max)}$  at  $T_a = 25 \text{ °C}$
- (3) Compatible with TTL outputs:  $V_{IL} = 0.8 \text{ V (max)}$

$$V_{IH} = 2.0 \text{ V (min)}$$

- (4) Output current:  $|I_{OH}|/I_{OL} = 24 \text{ mA (min)} (V_{CC} = 4.5 \text{ V})$
- (5) Balanced propagation delays:  $t_{PLH} \approx t_{PHL}$
- (6) Pin and function compatible with 74F240/244.

#### 4. Packaging



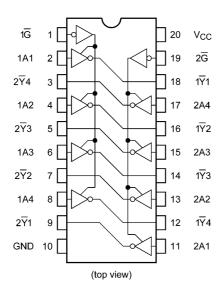
Start of commercial production

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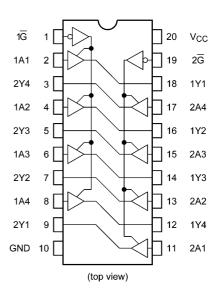


#### 5. Pin Assignment

#### TC74ACT240P

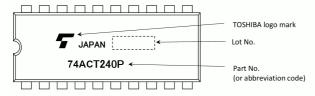


#### TC74ACT244P

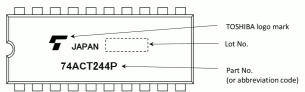


## 6. Marking

#### TC74ACT240P

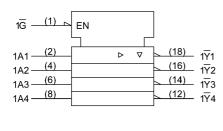


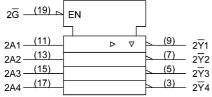
#### TC74ACT244P



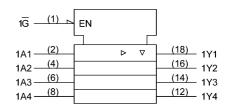
## 7. IEC Logic Symbol

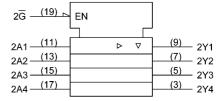
#### TC74ACT240P





#### TC74ACT244P





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#### 8. Truth Table

Input G	Input An	Output Yn (TC74ACT244P)	Output Yn (TC74ACT240P)
L	L	L	Н
L	Н	Н	L
Н	Х	Z	Z

X: Don't care

Z: High impedance

## 9. Absolute Maximum Ratings (Note)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		-0.5 to 7.0	V
Input voltage	V <sub>IN</sub>		-0.5 to V <sub>CC</sub> + 0.5	V
Output voltage	V <sub>OUT</sub>		-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>		±20	mA
Output diode current	I <sub>OK</sub>		±50	mA
Output current	l <sub>out</sub>		±50	mA
V <sub>CC</sub> /ground current	I <sub>CC</sub>		±200	mA
Power dissipation	$P_D$	(Note 1)	500	mW
Storage temperature	T <sub>stg</sub>		-65 to 150	°C

Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even Note: destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: 500 mW in the range of  $T_a$  = -40 to 65 °C. From  $T_a$  = 65 to 85 °C a derating factor of -10 mW/°C shall be applied until 300 mW.

# 10. Operating Ranges (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V <sub>CC</sub>	4.5 to 5.5	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	-40 to 85	°C
Input rise and fall times	dt/dv	0 to 10	ns/V

The operating ranges must be maintained to ensure the normal operation of the device. Note: Unused inputs must be tied to either V<sub>CC</sub> or GND.

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#### 11. Electrical Characteristics

## 11.1. DC Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Test Condition		V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		4.5 to 5.5	2.0	_	_	V
Low-level input voltage	V <sub>IL</sub>	_		4.5 to 5.5	_	_	0.8	V
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	4.5	4.4	4.5	_	V
			I <sub>OH</sub> = -24 mA	4.5	3.94	_	_	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA	4.5	_	0.0	0.1	V
			I <sub>OL</sub> = 24 mA	4.5	_	_	0.36	
3-state output OFF-state leakage current	I <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$		5.5	_	_	±0.5	μА
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	±0.1	μА
Quiescent supply	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5			8.0	μА
current	I <sub>CCT</sub>	Per input: V <sub>IN</sub> = 3.4 V Other input: V <sub>CC</sub> or GND		5.5	-	_	1.35	mA

## 11.2. DC Characteristics (Unless otherwise specified, Ta = -40 to 85 °C)

Characteristics	Symbol	Test Condition		Note	V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>	_			4.5 to 5.5	2.0		V
Low-level input voltage	V <sub>IL</sub>	_			4.5 to 5.5		8.0	V
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA		4.5	4.4		V
			I <sub>OH</sub> = -24 mA		4.5	3.80		
			I <sub>OH</sub> = -75 mA	(Note 1)	5.5	3.85		
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IH}$ or $V_{IL}$	$I_{OL}$ = 50 $\mu$ A		4.5	ı	0.1	V
			I <sub>OL</sub> = 24 mA		4.5	_	0.44	
			I <sub>OL</sub> = 75 mA	(Note 1)	5.5	_	1.65	
3-state output OFF-state leakage current	l <sub>OZ</sub>	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $V_{OUT} = V_{CC} \text{ or GND}$			5.5	I	±5.0	μА
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND			5.5	_	±1.0	μА
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND			5.5	_	80.0	μΑ
	I <sub>CCT</sub>	Per input: V <sub>IN</sub> = 3.4 V Other input: V <sub>CC</sub> or GND			5.5	_	1.50	mA

Note 1: This spec indicates the capability of driving 50  $\Omega$  transmission lines. One output should be tested within a 10 ms maximum duration.

## 11.3. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Part Number	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
Propagation delay time		t <sub>PLH</sub> ,t <sub>PHL</sub>		$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	5.0 ± 0.5	_	5.7	8.0	ns
3-state output enable time		$t_{PZL}, t_{PZH}$		$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	$5.0 \pm 0.5$	_	6.0	9.0	ns
3-state output disable time		$t_{PLZ}, t_{PHZ}$		$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	5.0 ± 0.5	_	5.9	8.5	ns
Input capacitance		C <sub>IN</sub>		_		_	5	10	pF
Output capacitance		C <sub>OUT</sub>		_		_	10	_	pF
Power dissipation	TC74ACT240P	C <sub>PD</sub>	(Note 1)	_			25	_	pF
capacitance	TC74ACT244P		(Note 1)	_			29		

Note 1:  $C_{PD}$  is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.  $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{|N} + I_{CC}/8 \text{ (per bit)}$ 

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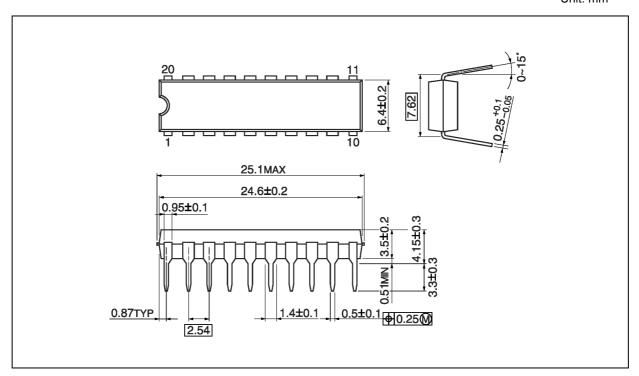
# 11.4. AC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	Min	Max	Unit
Propagation delay time		$C_L$ = 50 pF $R_L$ = 500 $\Omega$	5.0 ± 0.5	1.0	9.0	ns
3-state output enable time		$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	$5.0 \pm 0.5$	1.0	10.5	ns
3-state output disable time	$t_{PLZ},t_{PHZ}$	$C_L = 50 \text{ pF}$ $R_L = 500 \Omega$	$5.0 \pm 0.5$	1.0	10.0	ns
Input capacitance	C <sub>IN</sub>	_			10	pF



## **Package Dimensions**

Unit: mm



Weight: 1.30 g (typ.)

	Package Name(s)
Nickname: DIP20	



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